Haocheng Dai

Contact Information

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Summary

My research interest is centered on developing specialized and trustworthy machine learning tools. My focus extends to, but is not limited to:

- Trustworthy Machine Learning [1, 2]
- Multimodal Learning, Vision Language Models, and Diffusion Models [1, 4, 7]
- Geometric Deep Learning and Shape Modeling [3, 6, 8, 9]
- Physics-informed Machine Learning [5, 6]

Work Experience

Amazon

Applied Scientist-LLM, Shopping Convo Foundation

Seattle, USA 2024 - Present

Working on the next generation conversational shopping assistant Rufus.

Amazon Seattle, USA

Applied Scientist Intern

Design diffusion models for text inpainting [4].

2023 2022

Design vision language models for visual documents understanding [7].

Education

University of Utah

Salt Lake City, USA

Ph.D. in Computer Science

2019 - 2024

Committee: S.C. Joshi (Advisor), M. Bauer, S. Elhabian, P.T. Fletcher, R.M. Kirby

Tongji University

Shanghai, China

B.Eng. in Computer Science and Technology

2015 - 2019

Institut de Mathématiques de Toulouse

Toulouse, France

Exchange Student in Mathematics

2019

Technion - Israel Institute of Technology

Haifa, Israel

Exchange Student in Electrical Engineering

2018

Publications & Preprints

- 1. Refining Skewed Perceptions in Vision-Language Models through Visual Representations. H. Dai, S. C. Joshi, *Preprint*, **3**.
- 2. The Silent Majority: Demystifying Memorization Effect in the Presence of Spurious Correlations, C. You*, <u>H. Dai</u>*, Y. Min*, J. Sekho, S. C. Joshi, J. Duncan (*equal contribution), *Preprint*, §.
- 3. High-Fidelity CT on Rails-Based Characterization of Delivered Dose Variation in Conformal Head and Neck Treatments, <u>H. Dai</u>, V. Sarkar, C. Dial, M. Foote, Y. Hitchcock, S. C. Joshi, B. J. Salter, *Applied Radiation Oncology (ARO) 2023*, **©**.
- 4. Detect Al-generated Images Uploaded for Risk Evidence Collection in Customer Self-Service Workflow, <u>H. Dai</u>, S. Chen, B. Xiao, Y. Chen, *Amazon Machine Learning Conference (AMLC) 2023*, §.

- 5. Neural Operator Learning for Ultrasound Tomography Inversion, <u>H. Dai</u>*, M. Penwarden*, R. M. Kirby, S. C. Joshi (*equal contribution), *International Conference on Medical Imaging with Deep Learning (MIDL) 2023*, §.
- 6. Modeling the Shape of the Brain Connectome via Deep Neural Networks, <u>H. Dai</u>, M. Bauer, P. T. Fletcher, S. C. Joshi, *International Conference on Information Processing in Medical Imaging (IPMI) 2023*, Oral Presentation, §.
- 7. Understanding Visual Documents from Customer Self-Service Workflow using Multimodal Transformer, <u>H. Dai</u>, J. Chou, S. Chen, B. Xiao, Y. Chen, *Amazon Machine Learning Conference (AMLC) 2022*, §.
- 8. Integrated Construction of Multimodal Atlases with Structural Connectomes in the Space of Riemannian Metrics, K. M. Campbell, <u>H. Dai</u>, Z. Su, M. Bauer, P. T. Fletcher, S. C. Joshi, *Journal of Machine Learning for Biomedical Imaging (MELBA) 2022*, §.
- 9. Structural Connectome Atlas Construction in the Space of Riemannian Metrics, K. M. Campbell, <u>H. Dai</u>, Z. Su, M. Bauer, P. T. Fletcher, S. C. Joshi, *International Conference on Information Processing in Medical Imaging (IPMI) 2021*, François Erbsmann Prize (**Best Paper Award**), §.

Services

Reviewer

- Conferences: ACM MM, AISTATS, CVPR, ICLR, MICCAI, MIDL, NeurIPS
- Journals: ACM TIST, Medical Image Analysis, MELBA, Scientific Reports
- Workshops: AI for Differential Equations in Science@ICLR, WiCV@ECCV

Honors & Awards

François Erbsmann Prize (Best Paper Award), *IPMI 2021*Department Fellowship, *School of Computing, University of Utah*Chinese Government Scholarship, *Chinese Scholarship Council*Tongji Scholarship of Excellence (2016, 2017, 2018), *Tongji University*

Technical Skills

Python, MatLab, C++, PyTorch